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# Total Integrated Dose Testing of Solid-State Scientific CD4011, CD4013, and CD4060 Devices by Irradiation With CO-60 Gamma Rays

Armando Roberto V. Dantas Michael K. Gauthler James R. Coss

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May 15, 1985



Prepared for and in cooperation with

TRW Components International

Through an agreement with

National Aeronautics and Space Administration
by

Jet Propulsion Laboratory California Institute of Technology Pasadena, California

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#### ABSTRACT

The total integrated dose response of three CMOS devices manufactured by Solid State Scientific has been measured using CO-60 gamma rays. Key parameter measurements were made and compared for each device type. The data show that the CD4011, CD4013 and CD4060 produced by this manufacturer should not be used in any environments where radiation levels might exceed 1,000 rad(Si).

#### ACKNOWLEDGMENTS

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#### I. INTRODUCTION

The purpose of this report is to present the results of an investigation into the total integrated dose (TID) tolerances of three Complementary Metal-Oxide Semiconductor (CMOS) devices manufactured by Solid State Scientific.

Their CD4011B (Quad 2 - input NAND), CD4013B (Dual D-type Flip-Flop) and CD4060 (14-stage Counter and Oscillator) were irradiated with cobalt-60 gamma rays as part of JPL Task Plan No. 20-2424, "Radiation Effects: Commercial Microcircuits," per request of TRW Components International.

#### II. EXPERIMENTAL PROCEDURES

The JPL cobalt-60 gamma ray source produces primarily 1.17- and 1.33-MeV photons and secondary electrons arising from scattering and absorption. These spectra, passing through the case materials, result in an effective energy of 1.22 MeV at the chip. The gamma field is uniform within ±10% in the area where devices are exposed, as determined by thermoluminescent dosimetry (TLD), using 1ithium fluoride/Teflon microrods. Main source calibration was performed with Landswerk ion chambers of ±2% accuracy, traceable to the National Bureau of Standards. Bimonthly dose rate computations were performed to account for the source decay.

No correction factors for possible dose enhancement effects have been applied to these data. Dose enhancement effects result from Hi-Z metallic overlays on the chip or Hi-Z package materials. In this series of tests, there were no known Hi-Z materials on, or in, the devices tested.

Five samples of each device type were chosen for testing per Radiation

Test Requirements (RTR) 112C-2, 114C-2 and 386-1 (see Appendices A, B and C).

Each device type sample came from one date code. Bias boards were constructed per the RTRs and bias voltages of 15 volts D.C. furnished by batteries. The

devices were held under bias during irradiation as well as during parametric testing.

After pre-irradiation parametric measurements, the CD4011 and CD4013 devices were irradiated in steps and post-irradiation measurements taken immediately after each irradiation. A specially designed test box was constructed for these measurements (Appendix pages A-3, A-4, B-3, and B-4), which was located just outside the cobalt-60 test cell. Bias power was momentarily switched off, while each device was individually removed from the bias board for testing.

The CD4060 were similarly held under bias (Appendix C), but transported to a different location where a programmed IT200 automatic tester was used to make measurements. In addition to the parametric tests listed on the RTR, the CD4060 program included a bit pattern of 1's and 0's to monitor functionality.

The time interval between irradiation periods for all devices ranged from 45 minutes to 1 hour. Total dose levels ranged from 1,000 to 100,000 rad(Si); but not all devices were tested to the highest levels due to parametric degradation. Dose rates ranged from 3.33 to 10 rad(Si)/sec.

A computer was used to process the data, and calculate the mean, maximum and minimum  $\Delta$ 's. This program presents the data and graphs in Gray(Si) and Gy(Si)/sec\*.

All devices were CMOS and handled in such a manner to prevent damage due to electrostatic discharge.

To test the operational integrity of the test box, stock CD4011 and CD4013 devices were obtained from JPL Electronic Stores and measured under the same conditions as the DUT's. This verified that the test box was performing properly.

 $<sup>*1 \</sup>text{ Gy(Si)} = 100 \text{ rad(Si)}.$ 

#### III. DISCUSSION OF RESULTS

The test results for CD4011, CD4013, and CD4060 devices are shown in Appendixes D, E, and F respectively. The graphs showing mean values are presented as Figures 1 through 13 following the conclusions. In the graphs, for all three device types, IDD1 represents the Quiescent Current with the outputs tied high, while IDD2 represents the Quiescent Current with the outputs tied low.

In the CD4011 and CD4013 device graphs, VTN represents the N-Threshold Voltage, while VTP represents the P-Threshold Voltage. The number following VTN or VTP (VTN3, etc.) designates the device pin at which the measurement was taken.

In the case of the VTN and VTP graphs for the CD4060, these still designate Threshold Voltage measurements, but the numbers 1 and 2 designate that measurements were taken at device pins 11 and 12 respectively.

#### A. CD4011

These devices appeared to be damaged before arrival at JPL. All initial threshold voltages (VTN) were out of range (-10 volts) on all pins. Initial IDD readings were less than a nanoamp but increased to their maximum specified value at 5,000 rad(Si) TID (Figure 1). There was no measurable recovery noted for these devices one week after their last irradiation.

#### B. CD4013

Threshold voltages showed measurable degradation with 1,000 rad(Si) and were well beyond tolerable levels (> 3 times increase) at 2,000 rad(Si) (Figure 2). Leakage current measurements (IDD) show a similar trend (Figures 3 through 10). As with the CD4011, these devices did not show any measurable recovery one week after their last irradiation.

#### C. CD4060

These devices were degraded by radiation in a manner similar to the CD4013 devices (Figures 11 through 13) showing measurable degradation at 1000 rad(Si) and failure by 2,000 rad(Si). It should be noted, however, that the programmed bit pattern was maintained until these devices had received a total dose between 50,000 and 100,000 rad(Si). Further, they did show some recovery by the reinstatement of the bit pattern 24 hours after the last irradiation and some parametric improvement one week later.

#### IV. CONCLUSIONS

From these test results, these devices cannot be recommended for use in an environment where they may receive more than very low radiation levels [ $\leq 1,000$  rad(SI)].

Also, it is believed that the SSS CD4011 devices probably sustained ESD damage before arriving at JPL.

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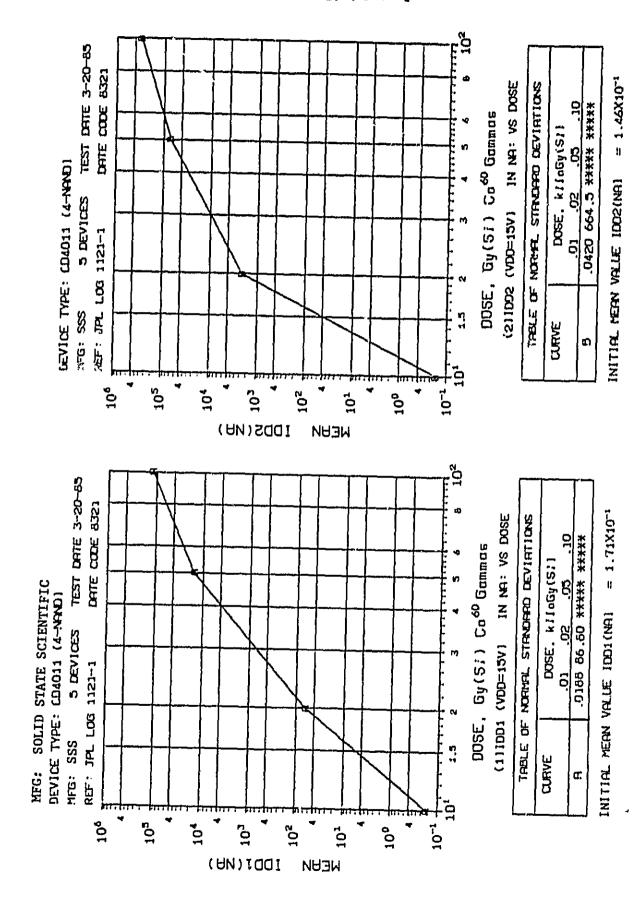


Figure 1. IDD1 and IDD2 for CD4011

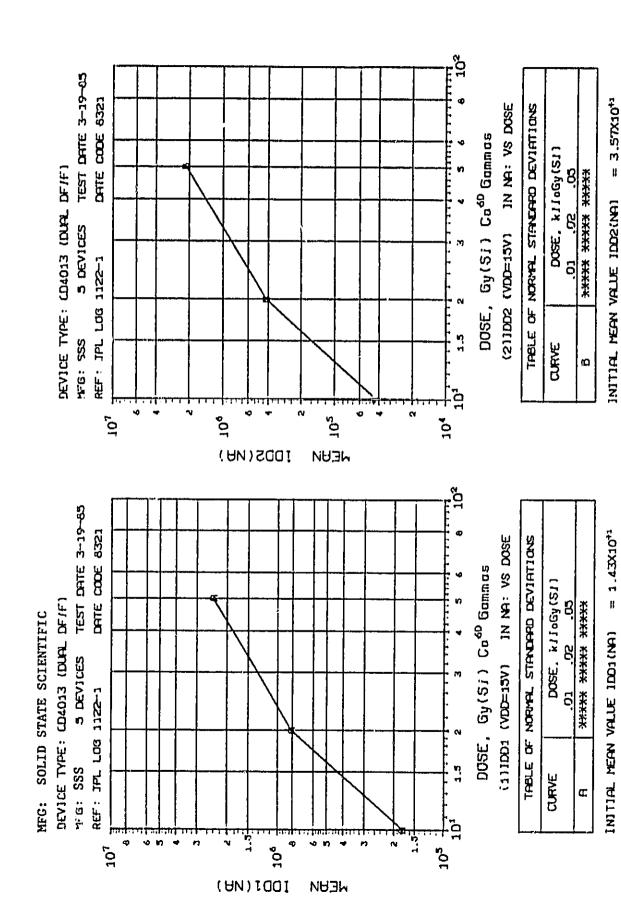


Figure 2. IDD1 and IDD2 for CD4013

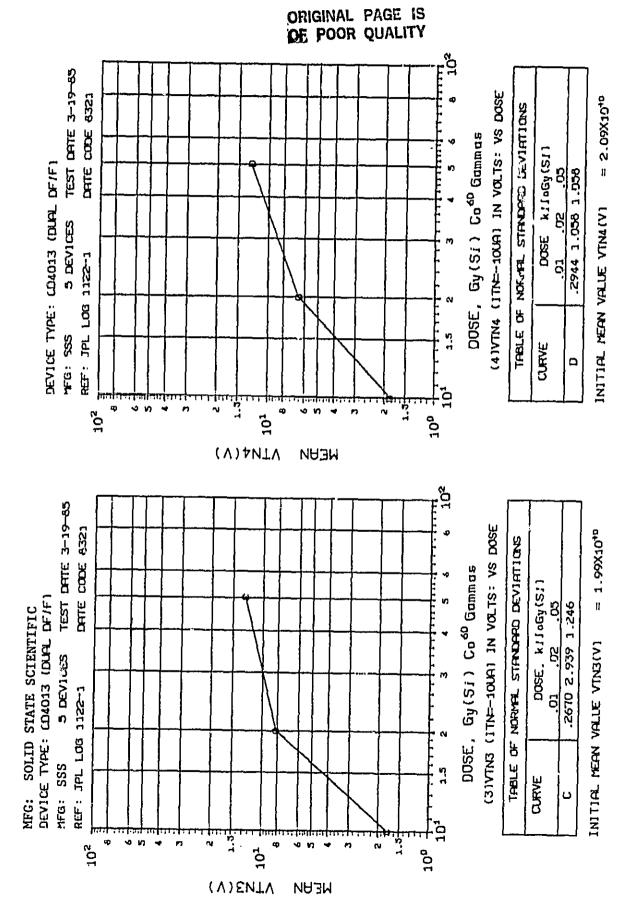


Figure 3. VIN3 and VIN4 for CD4013

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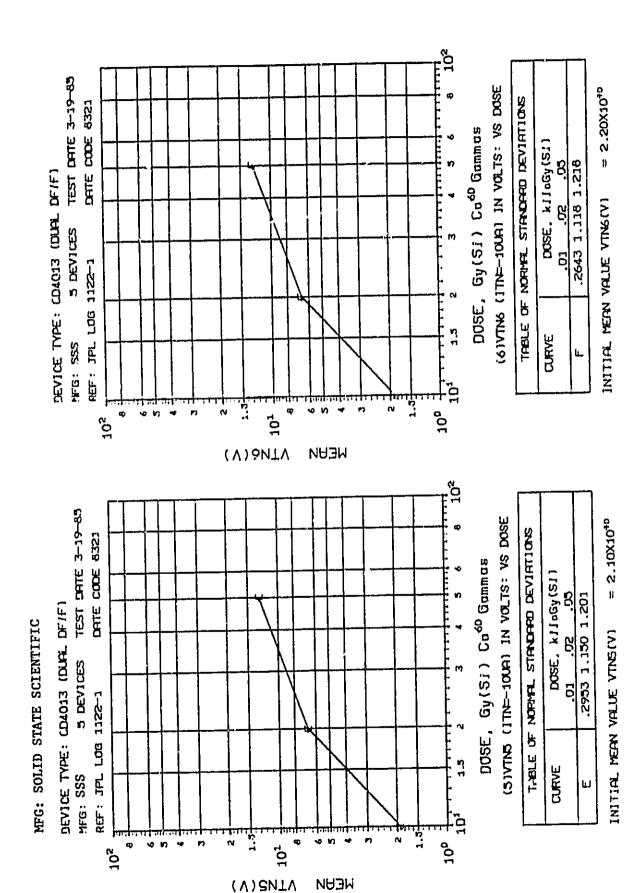


Figure 4. VIN5 and VIN6 for CD4013

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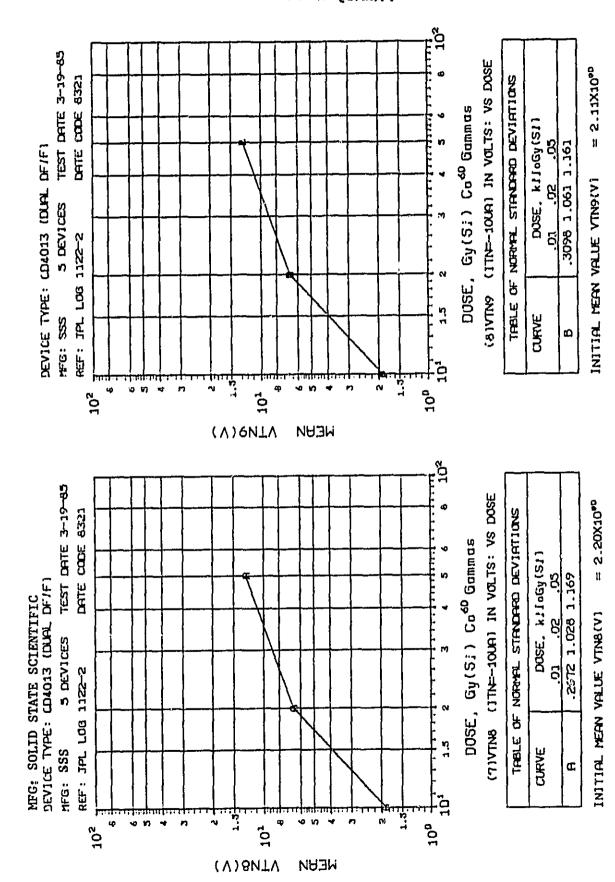


Figure 5. VIN8 and VIN9 for CD4013

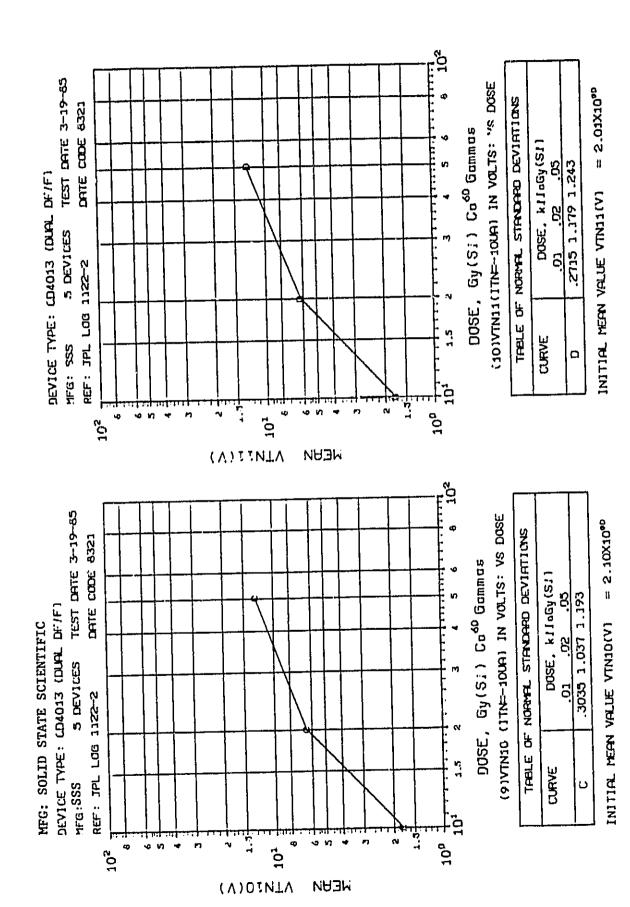


Figure 6. VINIG and VINIL for CD4013

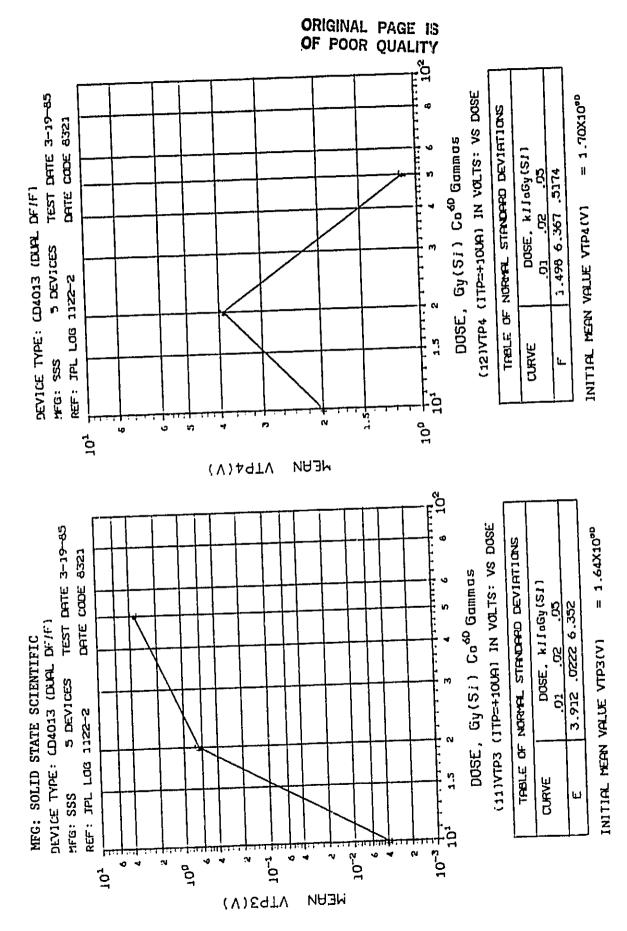


Figure 7. VTP3 and VTP4 for CD4013

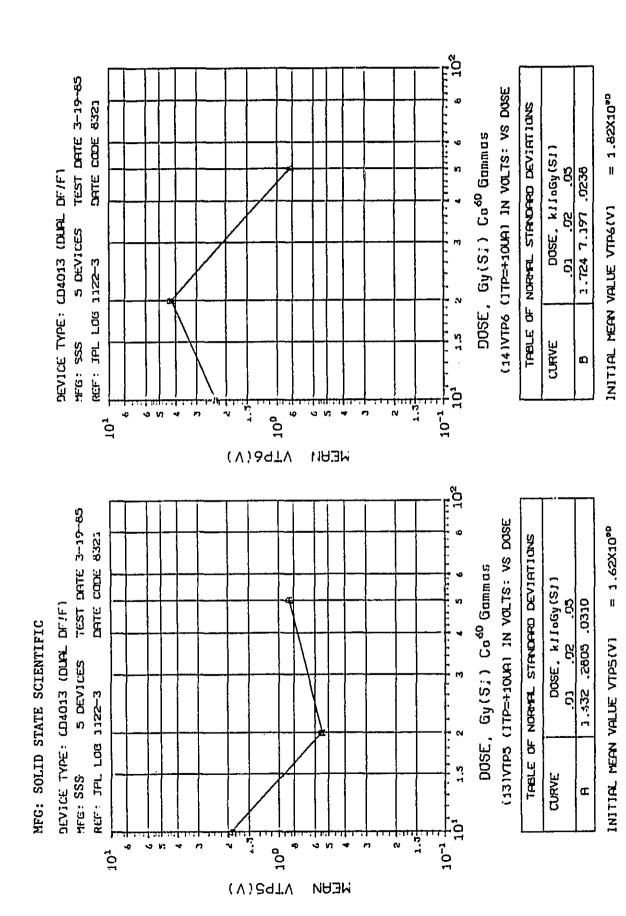


Figure 8. VIP5 and VIP6 for CD4013

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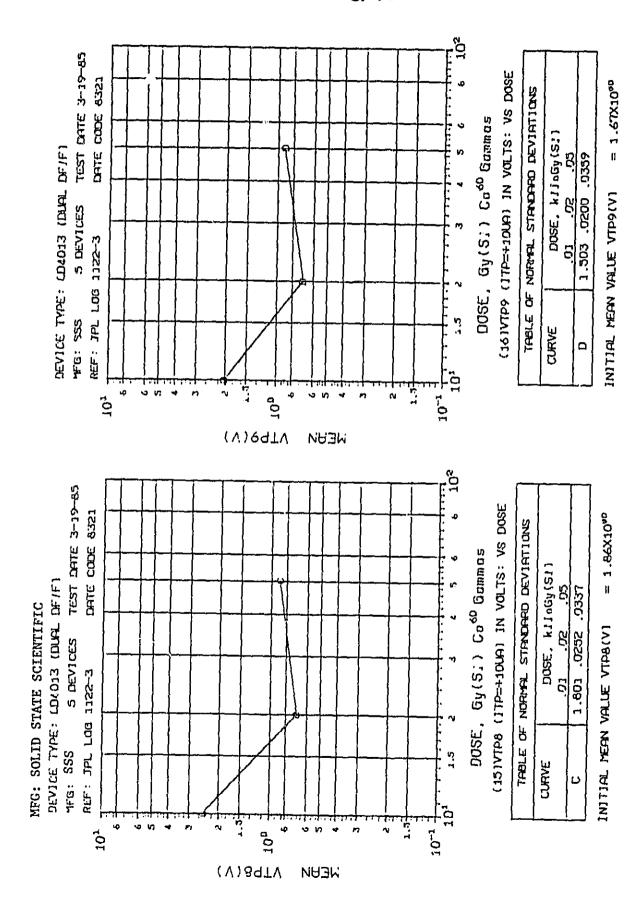


Figure 9. VTP8 and VTP9 for CD4013

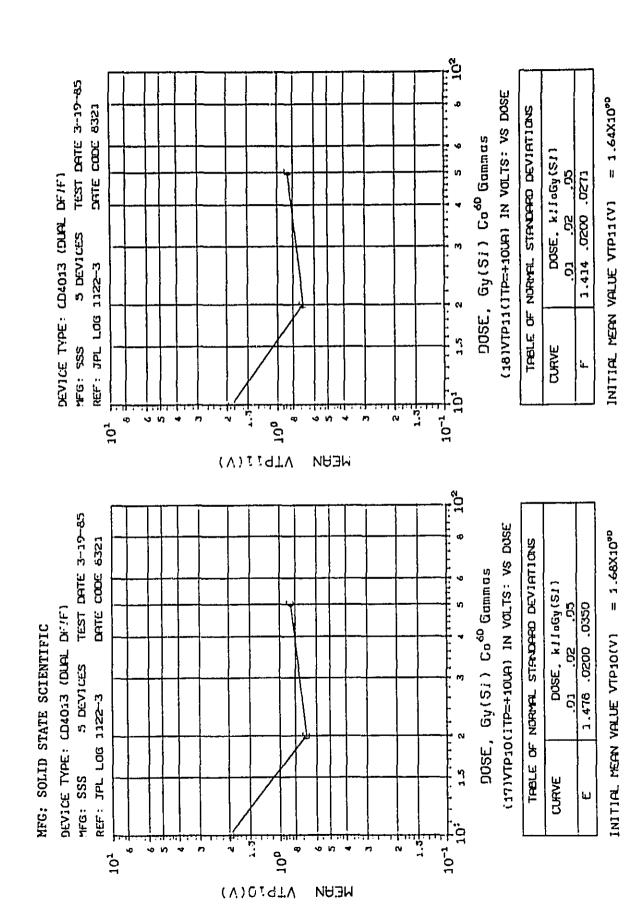


Figure 10. VTP10 and VTP11 for CD4013

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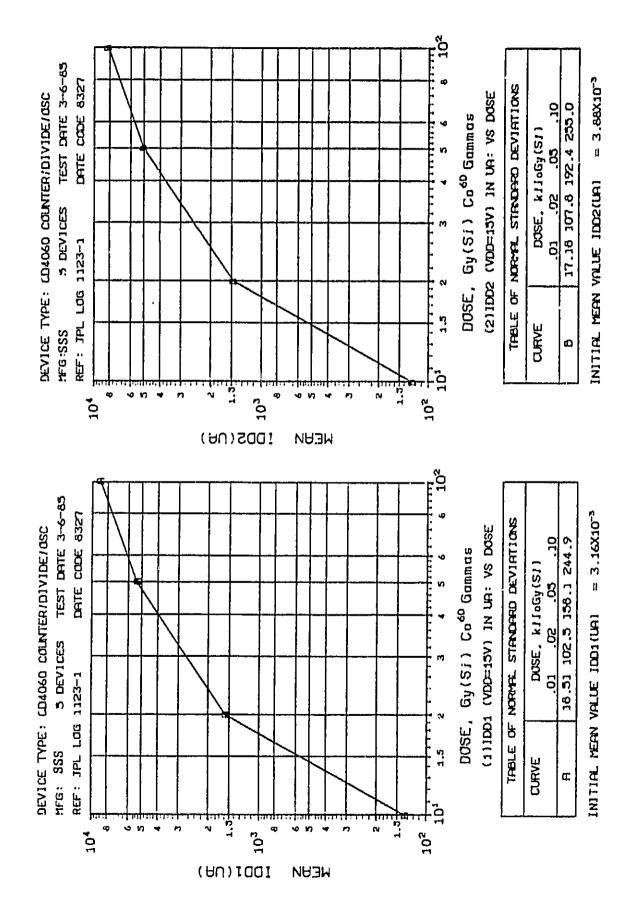


Figure 11. IDD1 and IDD2 for CD4060

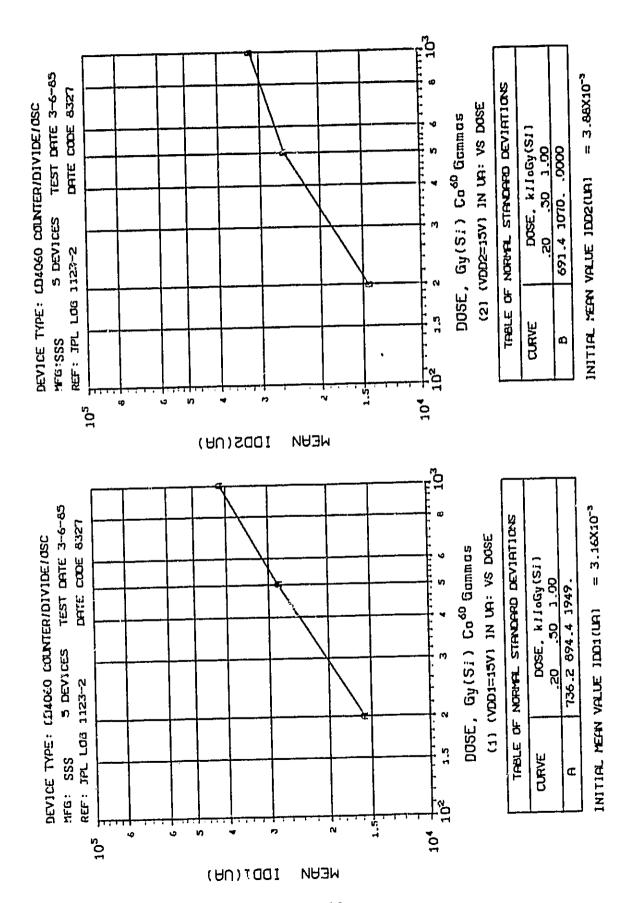


Figure 11. IDD1 and IDD2 for CD4060 (Continued)

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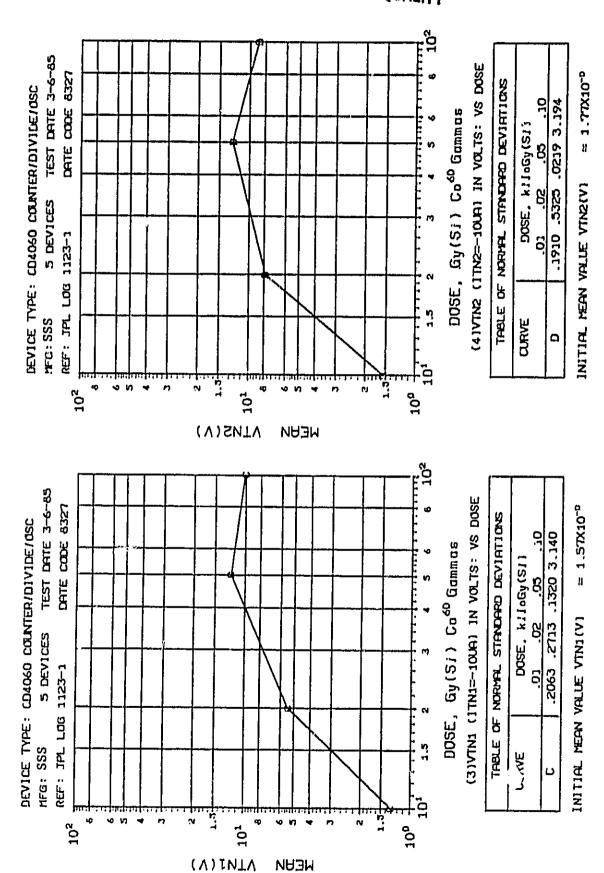


Figure 12. VINI and VINZ for CD4060

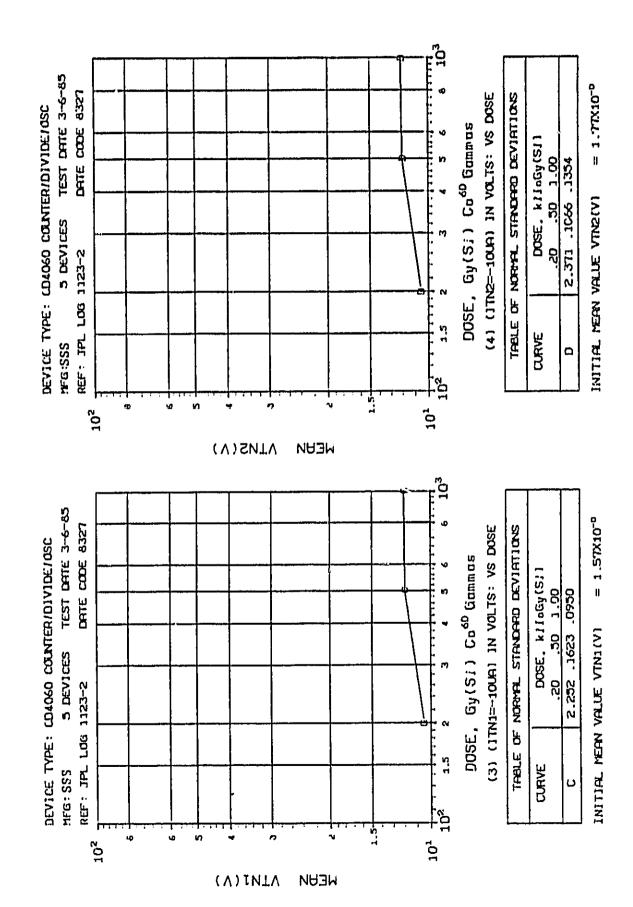


Figure 12. VTN1 and VTN2 for CD4060 (Continued)

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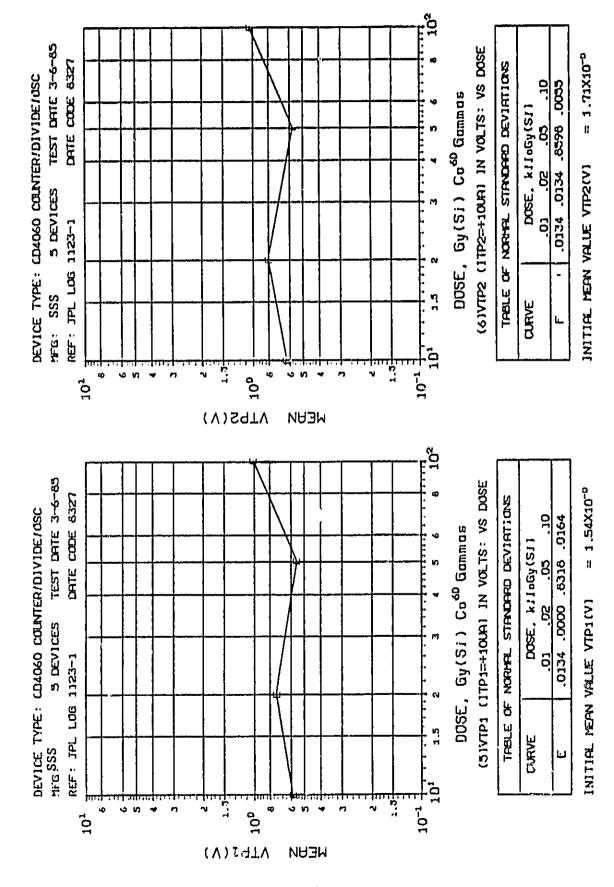


Figure 13. VTP1 and VTP2 for CD4060

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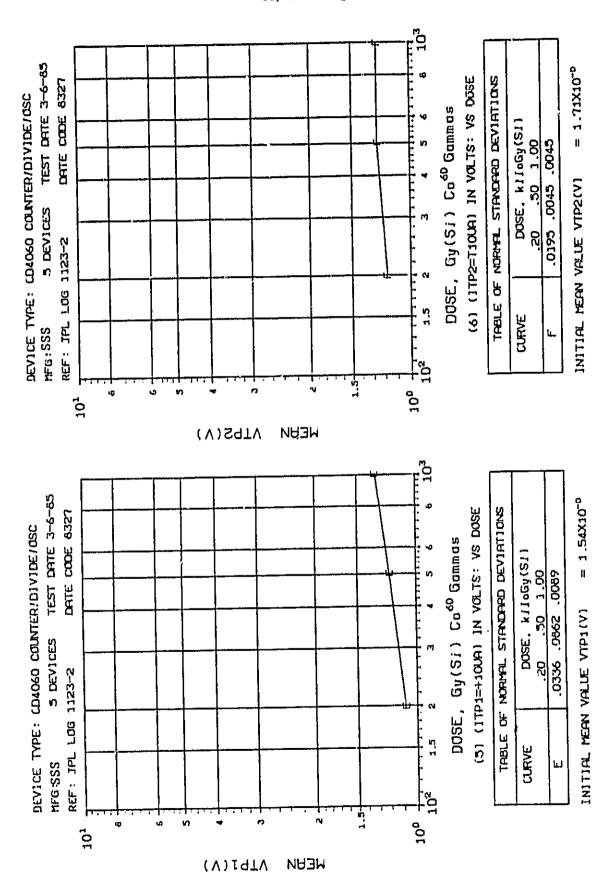


Figure 13. VTP1 and VTP2 for CD4060 (Continued)

# APPENDIX A RADIATION TEST REQUIREMENTS

## RADIATION TEST REQUIREMENTS

nearce table	<u> </u>	·NAND)		KIK 5/N	1120%	
Manufactur	er SSS				ce Package	
Lot No	D	ate Code	· · · · · · · · · · · · · · · · · · ·		Туре	No. of Leads
No. of Dev:	ces Supplied				DIP	14
	ices to be test					
535-6440	18-0-5140			1.		
RADIATION (	CONDITIONS:		UNITS	R	ADIATION LEVE	LS
Facility:	Co60	Fluence		see tab	le below	
Energy:	1.25 MeV	Flux				
BIAS CONDIT	TIONS DURING IN	RADIATION:	-			
Pin No.	Parameter	Voltage	Remark	В	Bias Circ	uit
1	In	10K to 15V		Flue	nce rad(Si)	Flux rad(Si)/sec
2	In	,,		12		3.33EO
3	Out	100K to 15V	low	2E 5E		3.33EO 1E}
4	Out	100k to GND	high	1E	4	1E1
5	In	Ground		2E 5E		1E1 1E1
6	In	Ground		1 1 1 1	5 <b>*</b>	iei
7	V <sub>SS</sub>	Ground				
8	In	10k to 15V				
9	In	11				
10	Out	100K to 15V	low			
11	Out	100K to GND	high			
12	In	Ground				
13	In	Ground				
14	V <sub>DD</sub>	15V-10k				
	1					
P(:		100				
/	9.10	M A				
V	P 73 (22	165				
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RADIATION TEST REQUIREMENTS

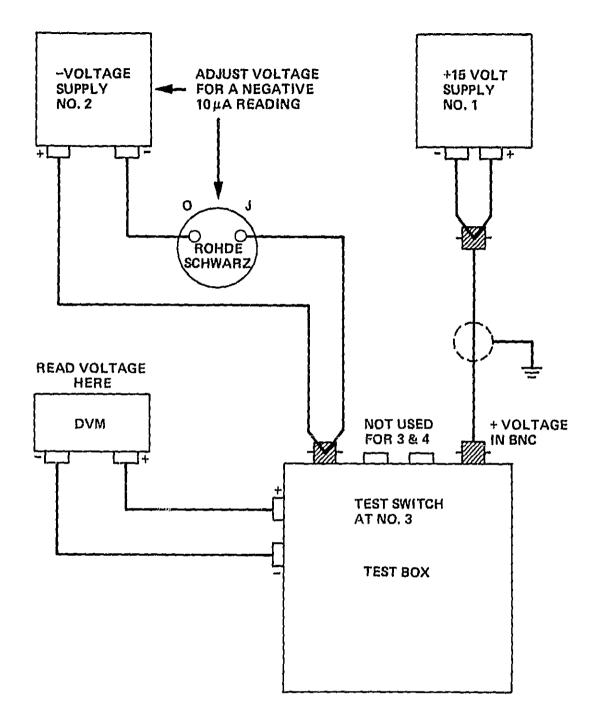
RTR S/N 112C-2

Device Typo: <u>CD4011 (4-NAND)-1</u>

JPL Contact:									
Name	Subsystem	Phone							
M. Gauthier	514	2126							
B. Dantas	514	4932							
ป. Coss	514	7463							
E. Powell	514	6175							

Test In Situ		Situ					
Sequence Number	Yes	No	Parameter	Test Conditions *	Remarks		
1		x	Quiescent Current	7 through current meter to Ground, 1,2,5,6,8,9,			
				12,13,14 to 15V			
2		×	Quiescent Current	14 to 15V, 7 through cur- rent meter to Ground,			
				1,2,5,6,8,9,12,13 to Ground			
3		х	N threshold**	1 to Ground, 14 to 15V, 2,5,6,8,9,12,13 and 7	Record VTN, 7 to GND		
				to -10,4A			
4		×	P threshold**	1 to Ground, 2,5,6,8,9, 12,13 and 7 to -15V,	Record VTP, 14 to GND		
				14 to +۱۵مبر			
			**N and P thresho	ld to be taken for p	ns 1,2,5,6,8,9,12,13		
	] ]			ground as per test!	_		
			i	trical parameters to be			
			and 1 week ti be kept under	ne periods after the fina bias till these readings	l irradiation, parts to are completed.		
		i					
_			*Use special test box	constructed, see page A-	-4		

Circuit Diagram for CD4011 and CD4013 Tester Box



SWITCH TO 4:
FOR TEST NO. 4, PLACE CURRENT METER ON
POSITIVE LINE OF SUPPLY NO. 1, INCREASE
VOLTS ON SUPPLY NO. 2 TO 15.00 READING
WITH DVM'. INCREASE VOLTAGE FROM ZERO
TO OBTAIN A +10 µA READING ON ROHDE SCHWARZ
METER. READ VOLTAGE AT DVM JACKS

Procedural Use for CD4011 and CD4013 Tester Box (Example shown is Test No. 3 for CD4011)

# APPENDIX B RADIATION TEST REQUIREMENTS

## RADIATION TEST REQUIREMENTS

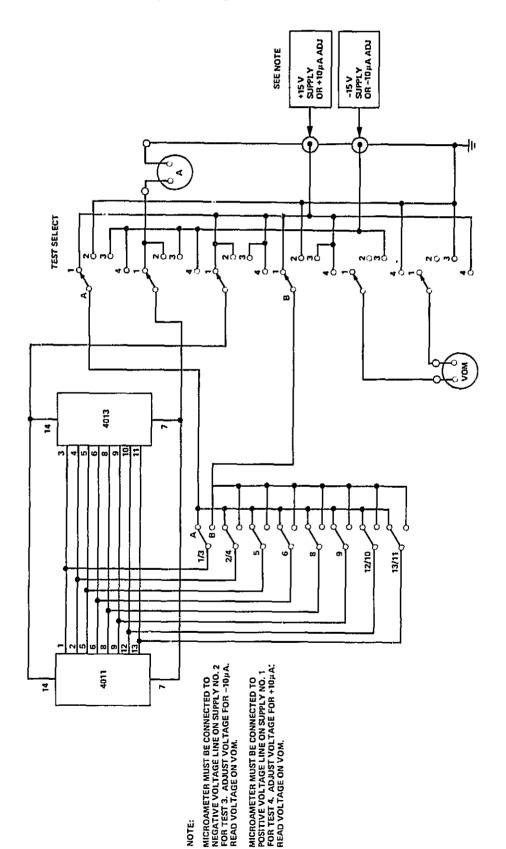
Device	e Type	LU 401	3 (DUAL D F/T)	<u> </u>	RTR 5/N_	1140-2	<del></del>
Manuf	ncturer	SSS			<del></del> ,		ice Package
Lot No	o	De	ite Code			Турс	No. of Leads
No. o	f Devic	es Supplied				DIP	14
No. o	E Devic	es to be test	ed5				
	54408-0				į		
	,,,,,,	0					
RADTA'	TION CO	NDITIONS:		UNITS	R	ADIATION LEV	ELS
•	ity: C	· · · · · · · · · · · · · · · · · · ·	Fluence		see table	below	
		.25 MeV	Flux				
				<u> </u>			
BIAS	CONDITI	ONS DURING I	RRADIATION:				
P1	n No.	Parameter	Voltage	Remark	B	Bias Cir	cuit
1	<i>C</i> 3.	oùt	100k to Gnd	high	Flu	uence rad(31	) Flux rad(Si)/sec
2	21	out	100k to 15V	low		1E3	3.33EO
3		clock	10k to 15V			2E3 5E3	3.33EO 1E1
4		reset	gnd			1E4	1E]
5		<b>I</b> n-Dլ	10k to 15V			2E4 5E4	1E1 1E1
6	<u>  - </u>	set	10k to 15V	ļ		1E5*	1E1
7		V <sub>SS</sub>	and				
8	, n	set	gnd				
9		In-02	qnd	ļ			
10	· .	reset	10k to 15V	<u> </u>			
11		clock	gnd				
12	Ğ.;	output	100k to and	high			
13	က,	output	100k to 15V	1ow			
14		ν <sub>DD</sub>	10k to 15V	<u> </u>			
	1				<del></del>		
	100		<del> </del>	<u> </u> 			
<del> </del>	1/\-		12				at the discretion of tes
·	M 4	4 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	12		engine	er/customer.	•
	1	- 1/2 C	10-1	<del> </del>			
		<u> </u>	- <del>  //</del>	-			

RADIATION TEST REQUIREMENTS RTR S/N 114C-2

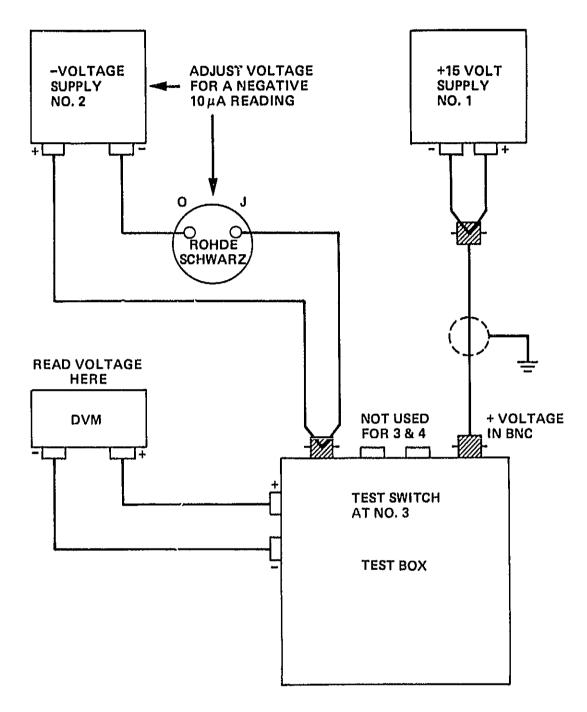
Device Type: CD4013 (Dual D F/F)

JPL Contact:				
Name	Subsystem	Phone		
M. Gauthier	514	2126		
B. Dantas	514	4932		
J. Coss	514	7463		
E. Powell	514	6175		
		l		

Test Sequence	In	Situ	<b>,</b>		
Number	Yes	No	Parameter	Test Conditions *	Remarks
		×	Quiescent Current	3,4,5,6,8,9,10,11,14 to 15V,7 through current	
				neter to ground	
2		×		14 to 15V, 7 through current meter to ground	
				3,4,5,6,8,9,10,11 to gnd	
<del></del> 3		x	N threshold**	3 to ground,14 to 15V, 4,5,6,7,8,9,10,11 to	record <sup>V</sup> TN, 7 to gnd
<del></del>				-10 <sub>A</sub> A	
4		x		3 to ground, 4,5,6,7,8,9,	record <sup>V</sup> TP, 14 to gnd
· <u>·</u>				14 t +10 MA.	
······································			**N and P thresho	d to be taken for pi	ns 3,4,5,6,8,9,10,11
			respectively to NOTE: All above elec	ground as per test b trical parameters to be r	ex design. etested at 24 hours and 1 we
			time periods a bias till the	fter the final irradiation readings are completed.	n, parts to be kept under
					_
			*To be tested in spe	ial box constructed, see	page B-4



Circuit Diagram for CD4011 and CD4013 Tester Box



# SWITCH TO 4: FOR TEST NO. 4, PLACE CURRENT METER ON POSITIVE LINE OF SUPPLY NO. 1, INCREASE VOLTS ON SUPPLY NO. 2 TO 15.00 READING WITH DVM'. INCREASE VOLTAGE FROM ZERO TO OBTAIN A +10 µA READING ON ROHDE SCHWARZ METER. READ VOLTAGE AT DVM JACKS

Procedural Use for CD4011 and CD4013 Tester Box (Example shown is Test No. 3 for CD4011)

# APPENDIX C RADIATION TEST REQUIREMENTS

#### RADIATION TEST REQUIREMENTS

Device	туре	CD4060 (Cot	inter/Divide/(	osc)	RTR	s/n _	386-1	<del></del>
Manufa	cturer	SSS					Do	evice Package
Lot No	) <b>.</b>	Dat	c Code				Турс	No. of Leads
No. of	Devic	es Supplied					DIP	16
No. of	Devic	es to be teste	eds_					
535-6	54408-0	D <b>-</b> 5140						
RADIA	TION CC	NDITIONS:		UNITS		RAT	NATION LE	VELS
Facil	lty: _	060	Fluence	see ta	ble bel	ov_		
		1.25 MeV	Flux				_	
		·		77				
		ONS DURING IRE	ADIATION:	,——	<del></del>			
P11	No.	Parameter	Voltage	Remark	.B		Bias Ci	rcuit
		012	100k to and		F1	uence	rad(Si)	Flux rad(Si)/sec
2_		013	100k to and			1E3		3.33E0
		014	100k to and			2E3 5E3		3.33EO 1E1
4		06	100k to and			1E4		1E1 1E1
_5_		QE	100k to gnd			2E4 5E4		1E1
6		Q7	100k to gnd			1E5		1E1
_7		04	100k to gnd					
88		V <sub>SS</sub>	ground				Diagram	<u>#1</u>
9		фо	see diagram				1	ነለふ
10		<u></u>	#1		ţ			<b>√</b>
_11		<b>0</b> 1	13				11	2004.0
12		reset	and					300K A 33µF
_13		0,9	100k to gnd				9	
14		08	100k to and					
15		Q10	100k to gnd					
16		V <sub>DD</sub>	10k to 15V					
				1 }				
_41	<u>ب ک</u>	·						
U'\_	7	1. I Re	<u>'</u>		×Fu	rther	radiation	s at the discretion
	100	1 11 1	77.					customer.

RADIATION TEST REQUIREMENTS

RTR S/N 386-1

Device Type: <u>CD4060 (Counter/Divide/OSC)</u>

Name	Subsystem	Phone
M. Gauthier	514	2126
B. Dantas	514	4932
J. Coss	514	7463
E. Powell	514	6175
E. FUWEII	317	1
<del></del>		

Test Sequence In Situ		Situ			
Number	Yes	No	Parameter	Test Conditions	Remarks
1		×	Quiescent Current	d through current meter to ground, 11,12,14	
				to 15V	
2		x	Quiescent Current	8 through current meter to ground, 16 to 15V	
	<del>-  </del>			11,12 to ground	
3		×	N <sub>1</sub> threshold	11 to ground, 16 to 15V 8,12 to -10 AA	record <sup>V</sup> TN, 8 to gnd
4		×	P <sub>1</sub> threshold	11 to ground, 8,12 to -15V	record <sup>V</sup> TP,16 to gnd
		}		16 to +10µA	•
5			N <sub>2</sub> threshold	12 to gnd, 16 to 15V, 8&11 to -10µA	record <sup>V</sup> TN,8 to gnd
6			P <sub>2</sub> threshold	12 to gnd, 8&11 to -15V, 16 to +10 µA	record <sup>V</sup> TP, 16 to gnd
				<u>'</u>	· 
		<del></del>	NOTE: All above eld l week time	ectrical parameters to be t periods after the final irr	ested at 24 hours and adiation, parts to be
·	<del>  -</del> -		kept under b	ias till these readings are	completed.

# APPENDIX D RADIATION TEST RESULTS

PADIAT	ION TEST RESULTS	03/25/85
DEVICE TYPE CO401 MANUFACTHER SOLID PACKAGE TYPE DIP TEST CATE 3-20=	State Scientific	FACILITY CO60 ENERGY 1.25MEV RAP TEST REG 112-2 CIRCUIT NO.
SERIAL NUMBER ALL	LOT NUMBER	DATE CODE LOG NUMBER 8321 1121-1
DOSE GRAY(S1) PATE (GPAY/SEC)	10111AL 1.00E0 3.33=0	1 2.00E01 5.00E01 1.00E02 2 3.33=02 1.00=01 1.00=01
(1)1DD1 (VDD#15V)	IN VAL	
2052V 2053V 2054V 2055V 2056V	•181 •191 •165 •181 •191 •194 •170 •175 •15 •15	0 168.0 26.1E3 15.0E4 8 1.21 8.5E3 68.E3 5 .178 8.15 81.0E3
MAX Mean Min Mean + 3 Siumi	.191+00 .198+00 .171+00 .180+00 .150+00 .151+00 .218+00 .236+00	0 .642+02 .155+05 .120+06 0 .178+00 .815+01 .680+05
(5)1005 (ADD#12A)	IN NAE	
2052V 2053V 2054V 2055V 2056 V	.155 .176 .141 .145 .165 .165 .139 .141 .13 .245	5 1.9E3 69.1E3 30.0E4 5 1.58E3 56.0E3 23.0E4 1 1.54E3 65.0E3 27.5E4 5 3.12E3 86.0E3 39.0E4
MEAN MIN MEAN + 3 SIGMA	.165+00 .245+00 .146+00 .174+00 .130+00 .141+00 .188+00 .300+00	211+04 .714+05 .315+06 0 .154+04 .560+05 .230+06
(3) VTN1 (ITNE+10UA)	IN VOLTS:	
2052V 2053V 2054V 2055V 2056V	=10.29 ******** =10.37 ******* =10.41 ****** =10.15 ****** =10.32 ******	********* ****** ******* ******** ****** ********
MAX Meah Min Meah + 3 sigma	101+02 ******* 103+02 ****** 104+02 ******* 100+02 *******	******

RAD	IATION TEST	RESULTS	03/25/65	
MANUFACTURER SOI PACKAGE TYPE DI		NTIFIC ENE	ILITY CO60 RGY 1.25ME TEST REQ 112#2 CUIT NO.	<b>V</b>
SERIAL NUMB A	EH LOT H	UHBER D	ATE CODE LOG 8321	NUMBER 1121-1
DOSE GRAY(SI RATE (GRAY/SEC			2.00E01 5.00E01 3.33-02 1.00-01	1.00E02 1.00m01
(4) YTN2 (ITN=+1	OUA) IN VOLT	St		
2052 V 2053 V 2054 V 2055 V 2056 V		7 ******* * 1 ******* * 4 ******	****** ****** ****** ******* ****** ******* ****** ******	*******
MAX MEAN Min Mean + 3 S	104+0	5 ******* *		***
(5) VTN5 (ITN=1	OUA) IN VOLT	51		
2052v 2053v 2054v 2055v 2056v	=10.3 =10.4 =10.1	6 ******* * 6 *******	****** ******* ******* ****** ******* ******	*******
MAX MEAN MIN MEAN + 3 S		S ****** *	******* ******* ******* ******* ******* ******	*******
(6) VTN6 (ITN=1)	OUA) IN VOLT	8 t		
2052v 2053v 2054v 2055v 2056v	= 10.2 = 10.3 = 10.4 = 10.1 = 10.3	7 4444444 *: 1 4444444 *: 3 4444444   : 2 4444444   :	******* *******  ******* ******  ****** ******	*********
MAX MEAN MIN MEAN + 3 5)	=.101+0 =.103+0 =.104+0 IGHA =.998+0	S ******* *:	******** ******* ******** ******** ********	******** ******** *******

RAUI	ATION TEST PESULTS	03/25/85
PACKAGE TYPE DIP	ID STATE SCIENTIFIC	FACILITY CO60 ENERGY 1.25MEV RAD TEST REQ 112=2 CIRCUIT NO. 1
SERIAL NUMBE AL	<del>-</del>	DATE CODE LOG NUMBER 8321 1121=2
DOSE GRAY(S1) RATE (GRAY/SEC)		1 2.00E01 5.00E01 1.00E02 2 3.33-02 1.00-01 1.00-01
(7) VTN8 (1TN==	10UA) IN VOLTS:	
2052V 2053V 2054V 2055V 2056V	m10.29 ******* =10.37 ****** %19.42 ****** %10.13 ****** %10.32 *****	* ******* ****** ******
MAX Mean Min Mean + 3 Si	*******	* ******** ******
(8) VTN9 (ITN==	10UA) IN VOLTS:	* *******
2053V 2054V 2055V 2056V	=10,37 ****** =10,43 ****** =10,13 *****	* ******* ****** ******
MAX Mean Hin Mean + 3 bi		* ******* ****** ******* * *******
(9) VINI2 (ITNE=	10UA) IN VOLTS:	
2052V 2053V 2054V 2055V 2056V	=10.28 ******* =10.37 ******* =10.41 ****** =10.13 ****** =10.32 ******	* ******* ****** *******  * *******
MAX MEAN Min Mean + 3 51	= 101+02 ******* = 103+02 ****** = 104+02 ****** = 104+02 ******	* ******** ****** ******

	RADIATION	TEST RESULTS	n3/25/85
DEVICE TYPE HANUFACTURE PACKAGE TYP TEST DATE	R SOLID STAT	E SCIENTIFIC	FACILITY CO60 ENERGY 1.25MEV RAD TEST RED 112=2 CIRCUIT NO. 1
SEFIAL	NUMBER ALL	LOT NUMBER	DATE CODE LOG NUMBER 8321 1121#2
DOSE GRA RATE (GRAY		NITIAL 1.00E0 3.33=0	
(10)VTN13 (	ITN==10UA)	IN VOLTS:	
2: 2:	053V 054V 055V	-10-28 ******* -10-37 ******* -10-41 ****** -10-13 ****** -10-32 *****	* ******* ****** ******
MAX Mean Min Mean +	# , <b>#</b> ,	101+02 ******* 103+02 ****** 104+02 ****** 998+01 ****	* ******** ****** ******
(11)VTP1 (	ITP#+10UA)	IN VOLTS:	
5 5 5	052V 053V 054V 055V 056V	10.29 ******** 10.37 ******* 10.41 ******* 10.11 ******* 10.33 *******	* ******* ****** ****** * ******* ****** *******
MAX MEAN MIN MEAN +	•	104+02 ******* 103+02 ****** 101+02 ****** 107+02 ******	* ******* ****** ******
(12)VTP2 (	ITP#+10UA)	IN VOLTS:	
5. 5.	052V 053V 054V 055V 056V	10.29 ******* 10.37 ******* 10.42 ****** 10.11 ****** 10.33 ******	· · · · · · · · · · · · · · · · · · ·
MAX MEAN MIN Mean +		104+02 ******* 103+02 ****** 101+02 ****** 107+02 *****	* ******* ****** ****

#### RADIATION TEST RESULTS

#### 03/25/85

DEVICE TYPE CD4011 MANUFACTURER SOLID STATE PACKAGE TYPE DIP TEST DATE 3=20=85	Z SCIENTIFIC	FACILITY CO60 ENERGY 1.25MEV RAD TEST RED 112=2 CIRCUIT ND.	
SERIAL NUMBER ALL	LOT NUMBER	DATE CODE LOG NUMBE 8321 1121=	
POSE GRAY(S1) I RATE (GRAY/SEC)	NITIAL 1.00EG 3.33=0		
(13)VTP5 (ITP#+10UA)	IN VOLTS:		
20524	10.29 *****	** ******* ****** ****	***
2053v 2054v	10.42 *****	¥	
2055v 2056v	10.13 ******		-
	104+02 *****		
MEAN	103+02 *****	* ******* ****** ****	***
	101+02 ****** 106+02 ******	· · · · · · · · · · · · · · · · · · ·	***
(14) VTP6 (ITP#+10UA)	IN VOLYSI		
2052V 2053V	10.29 *******		
2054V	10.42 *****	** ******* ****** ****	
2055V 2056V	10.11 *******		
MAX .	104+02 4*****	* ********* *****	***
MEAN	103+02 ******	* ****** ****	
	101+02 ****** 107+02 ******		
		·	
(15) VTP8 (ITP#+10UA)	IN VOLTS:		
2052v	10.29 ******	* ******* *****	***
2053V 2054V	10.37 *******	* ******* *****	***
2055Y		* ******** ****** ****	•
20567	10.33 ******	* *******	***
MAX	104+02 *****	* ******* ****** ****	***
		* ******** ****** *****	
<u> </u>		* ******* ****** ****	

	PAVIATION TES	T REBULTS	03/25/85
DEVICE TYP MANUFACTUR PACKAGE TY TEST DATE	ER SOLID STATE SC	CIENTIFIC	FACILITY CO60 ENERGY 1.25MFV RAD TEST REG 112=2 CIRCUIT NO.
SERIAL	NUMBER LOT	NUMBER	DATE CODE LOG NUMBER 0321 1121+3
	AY(81) INIT Y/SEC)	IAL 1.00E0 3.33=0	1 2.00E01 5.00E01 1.00E02 2 3.33=02 1.00=01 1.00=01
(16)VTP9	(ITP#+10UA) IN	VOLTS:	
,	2053V 10 2054V 10 2055V 10	.11 ******	
MAX MEAN MIN MEAN	.103 .101	+05 +*****	* ******* ****** ****** * ******* ****** ******* * ******* ******
(17)VTP12	(ITP#+10UA) IN	VOLTSI	
	2053V 10 2054V 10 2055V 10	.38 ******** .41 ******* .11 ******	
MEAN MEAN MEAN	.103 .101	+02 ******* +02 ****** +02 ****** +02 ******	* ******* ****** ******
(18)VTP13	(ITP=+10UA) IN	VOLT61	
	2054V 10 2054V 10	.37 ******** .41 ******	* ******** ******* *******
MAX MEAN MIN MEAN	.103-	******* ******* ******* *******	电报单电路电路 电电台电路存储器 海南海南部南部

# APPENDIX E RADIATION TEST RESULTS

RAU	TATION TEST RESULTS	03/25/85	
HANUFACTURER SO PACKAGE TYPE DI	4013 Pid State Scientific P 14-85	FACILITY CO60 FNERGY 1.25 RAD TEST REG 1140 CIRCUIT NO.	MEV
BERIAL NUMB A	EN LOT NUMBER LL	DATE CODE L 8321	NUMBER 1 = 5 5 1 1
DOSE GRAY(31 RATE (GRAY/8EC	) INITIAL 1.00E(	01 2.00E01 5.00E 02 3.33=02 1.00=	01
(1) IUU1 (VDO=15	V) IN NAI		
2064Y 2065Y 2066Y 2067Y 2068Y	1.15 186 1.18 14.06 45.0 23.86 23.1 20.26 1.15 13.16	14 77E4 14 95E4 4.1 14 86E4 4.4	02 E6 E6
MAX Mean Min Mean + 3 5	.450+02 .238+0 .145+02 .178+0 .115+01 .131+0 .731+02 .311+0	06 .522+06 .242+	07 01
(5)1005 (ADD#12)	V) IN NAE		
2064V 2065v 2066v 2067V 2068v	.91 4.1E 1.12 4.2E 16.2 5.4E 159.0 5.2E 1.20 2.6E	4 28E4 4 52E4 3.44 4 51E4 4.04	18 E6 E6
MAX Mean Min Mean + 3 si	.159+03 .540+0 .357+02 .430+0 .910+00 .260+0 .243+03 .764+0	5 .420+06 .218+0 5 .280+06 .180+0	07 00
(3) VTN3 (ITN#+10	UA) IN VOLTS:		
2064v 2065v 2066v 2067v 2068v	-2.12 2.0 -2.15 1.5 -1.89 2.0 -1.62 1.6 -1.97 1.49	2 13.44 15.0 0 7.72 12. 9 7.17 12.2	01 •3 26
MAX Mean Min Mean + 3 si		1 .828+01 .128+0 1 .620+01 .121+0	)

		•••
RADIATI	ON TEST RESULTS	03/25/85
DEVICE TYPE CD4013 MANUFACTURER SOLID PACKAGE TYPE DIP TEST DATE 3-19-8	STATE SCIENTIFIC	FACILITY CO60 ENERGY 1.25MFV RAD TEST REQ 114C=2 CIRCUIT NO.
SERIAL NUMBER ALL	LOT NUMBER	DATE CODE LOG NUMBER
DOSE GRAY(81) RATE (GRAY/8EC)	INITIAL 1.00E0 3.33=0	
(4) VTN4 (ITNE=10UA)	IN VOLTS:	
2064v 2065v 2066v 2067v 2068v	=2.22 2.13 =2.29 1.63 =1.95 2.13 =1.96 1.93 =2.04 1.43	2 4.77 14.61 2 7.02 12.26 1 7.47 12.26
MAX Mean Min Mean + 3 Sigma	= a195+01	1 .657+01 .127+02
(5) VTN5 (ITN=+10UA)	IN VOLTS:	
2064V 2065V 2066V 2067V 2068V	-2.24 2.15 -2.28 1.63 -1.97 2.21 -1.97 2.03 -2.04 1.58	3 4.82 15.01 7.63 12.35 7.62 12.34
MAX Mean Min Mean + 3 sigma	228+01 .158+01	#674+01 .129+02 #482+01 .122+02
(6) VTN6 (ITNB=10UA)	IN VOLTS:	
2064V 2065V 2066V 2067V 2068V	-2.39 2.12 -2.45 1.64 -2.01 2.17 -2.02 1.98 -2.13 1.61	4.84 15.01 7.68 12.29 7.45 12.31
MAX Mean	201+01 .217+01 220+01 .190+01	.768+01 .150+02

-.220+01 .190+01 .671+01 .126+02

.161+01 .484+01 .122+02 .270+01 .101+02 .165+02

MEAN

MIN -.245+01 MEAN + 3 SIGMA -.158+01

#### RADIATION TEST RESULTS 03/25/45 DEVICE TYPE CD#013 FACILITY C060 MANUFACTURER SOLID STATE SCIENTIFIC ENERGY 1.25MEV PACKAGE TYPE DIP RAD TEST REU 114C=2 CIRC'T NO. TEST DATE 3-19-85 SERIAL NUMBER LOT NUMBER DATE CODE LOG NUMBER 8321 1122-2 DOSE GRAY(SI) INITIAL 1.00E01 2.00E01 5.00EU1 RATE (GRAY/SEC) 3.33-02 3.33-02 1.00-01 CITN==10UA) IN VOLTS: BATV(7) -2.37 20044 2,13 12.15 6,83 20654 -2.46 1.64 4.92 14.84 2.1A 20064 -2.03 7.53 12.24 2067V -1.99 1.95 7.29 17.22 200BV 6.79 -2.13 1.61 12.31 MAX -.199+01 .218+01 .753+G1 +14B+02 MEAN -,220+01 .190+01 .667+01 .128+02 MIN -.246+01 .161+01 492+01 +121+02 MEAN + 3 SIGMA #,157+01 .270+01 976+01 163+02 (B) VTN9 (ITN==10UA) IN VOLTS: V4905 -2.25 2,24 7.09 12.21 2065V -2.30 1.59 4.94 10.06 **5066A** -1.96 2.19 7.54 12.26 20674 -1.96 1.98 7.44 12.26 20684 -2.06 1.01 6.85 12.33 MAX -.196+01 .224+01 .754+01 .149+02 MEAN 10+115.= .192+01 .677+01 -128+02 MIN 159+01 -.230+01 .494+01 .122+02 MEAN + 3 SIGMA -. 162+01 .285+01 .995+01 ·163+07 (9) VTN10 (ITH==10UA) IN VOLTS: 20647 -2.23 2.05 6,71 12.21 1.48 2065V -2.28 4.83 14.93 Ve905 -1.97 2.12 7.61 12.24 20677 -1.98 1.79 6.99 12.26 2068V 6.48 -2.03 1.48 12.35 MAX -.197+01 .212+01 .701+01 .149+02 MEAN -,210+01 .178+01 .128+02 .652+01 MIN -.228+01 148+01 .483+01 -122+02

.269+01

.964+01

-164+02

MEAN + 3 SIGMA = 166+01

RAD	IATION TEST RESULTS	03/25/89	3
MANUPÄCTÜREP SÖ PACKAGE TYPE DI	4013 LLID STATE SCIENTIFIC P 14-85	FACILITY COE ENERGY 1.2 RAD TEST REG 114 CIRCUIT NO.	SHEV
SERIAL NUMB A	ER LOT NUMBER LL	DATE CODE 8321	LUG NUMBER 1122=2
DOSE GRAY(SI RATE (GRAY/SEC			
(10) YTH11 (ITH#+	IUUA) II VOLTSI		
. 2064 2065 2066 2067 2067 2068	#2.18 1 #1.90 2 #1.88 i	.45 4.42 18 .05 7.52 12 .64 7.02 12	2.07 4.93 2.11 2.22 2.22
MAX Mean Min Mean + 3 s	188+01 .205 701+01 .176 218+01 .146 1441 .257	+01 +630+01 +121 +01 +442+01 +121	7+02 7+02 1+02 1+02
(11)VTP3 (ITP#+	10UA) IN VOLTS:		
2064v 2065v 2066v 2067v 2068v	1.69 6 1.42 1.92 =2	.57 ******* .60 .69 15 .61 .65 .35 .70 .27 .69	•73 •01 •63 •86
MAX MEAR MIN MEAR + 3 5	.192+01 .660 .164+01 .400 .142+01257 .117	#02 #662+00 #365 +01 #650+00 #730	
(12)VTP4 (ITP#+	IVUA) IN VOLTS:		
2064v 2065v 2066v 2067v 2068v	1.84 =3 1.44 2.03 =2	.64 ******** .05 13.43 2 .63 .67 .66 .72 .34 .70	.84 2.03 .90 .91
MAX Mean Min Mean + 3 8	.203+01 .630 105.= 10+011. 205.= 10+041. 248. 241+01 .248	+01 •388+01 •111 +01 •670+00 •840	1+01 3+00

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RADIATION TEST RESULTS 03/25/85
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NUMBER 1122-3

DEVICE TYPE MANUFACTURER PACKAGE TYPE TEST DATE	CU4013 SOLID STATE SCIENTIFIC DIP 3-14-85	FACILITY CD60 ENERGY 1.25MEV RAD TEST REG 114Cm2 CIRCUIT NO.
SERIAL N	RBEMUN TOL HABERU ALL	DATE CODE LOR
DOSE GRAY!		
(13)VTP5 (ITF	P#+10UA) IN YOLISE	
206 206 206	1.69 =2.8 55	2 .13 ******* 3 .67 .88 7 .71 .89
MAX Mean Min Mean + 3	0+060. 10+201. 0+020. 10+201. 0+085. 10+85. AMPLE 8	1 .550+00 .862+00 1 .130+00 .820+00
(14) VTPb (ITP	PB+1UUA) IN VOLTS:	
205 206 206 206 206	55V 2.00 =3.6 56V 1.43 .6 57V 2.17 =2.9	3 15.08 ************************************
MAX Mean Min Mean + 3	.217+01 .630+0 .182+01234+0 .143+01363+0 .273+01 .283+0	1 •428+01 •835+00 1 •670+00 •800+00
(15)VTP8 (ITP	PH+10UA) IN VOLTSE	
205 206 206 206	55V 1.98 =3.79 66V 1.51 .6 7V 2.33 =3.29	1 •67 •91 9 •72 •91
MAX MEAN MIN Mean + 3	.233+01 .610+00 .186+01 = .249+00 .151+01 = .374+00 .266+01 .292+00	1 •697+00 •890+00 1 •670+00 •840+00

		RADIATION	TEST RESULTS	03/25/85	
DEVICE MANUFAC PACKAGE TEST DA	TURER	SOLID STAT	TE SCIENTIFIC	FACILITY CD60 ENERGY 1.25MEV RAD TEST REQ 114C=2 CIRCUIT NO.	
5ER	YAL N	UHBER ALL	LOT NUMBER		NUMBER 1122-3
DOSE HATE (	GRAY GPAY/		INITIAL 1.00E0 3.33=0	i 2.00E01 5.00E01 2 3.33=02 1.00=01	
116)YTP	9 (11	P=+1UUA)	IN VOLTS:		
	20 20 20 30	64V 65V 66V 67V 68V		1 .72 .94	
MA ME MI ME	A <sub>I</sub> J N	3 SIGPA	.278+01 .610+0 .167+01 =.203+0 .133+01 =.307+0 .255+01 .248+0	1 •700+00 •912+00 1 •689+00 •860+00	
(17)VTP	10(17)	P#+1UUA)	in völfs:		
		57Y	1.72 =2.79 1.73 =2.89 1.50 .69 1.92 =2.00 1.52 +2.3	3 .68 .88 6 .72 .85	
MA ME ME	ÄN N		.192+01 .630+06 .168+01199+09 .150+01 w.283+09 .220+01 .244+09	1 •700+00 •862+00 1 •680+00 •810+00	
(18)VTP	11(ITF	P=+10UA)	IN VOLTET		
	206 206 206 206	55V 56V 57V	1.60 =2.35 1.73 =2.65 1.47 .66 1.91 =2.36 1.51 =2.66	2 ######## ####### 4	
MA; ME, MII ME,	H H		.191+01 .640+00 .164+01188+00 .147+01266+00 .216+01 .236+01	1 •710+00 •870+00 1 •690+00 •830+00	

# APPENDIX F RADIATION TEST RESULTS

#### RADIATION TEST RESULTS 03/13/85

MANUFACTURER SCLI PACKAGE TYPE DIP TEST DATE 3-6-	D STATE SCIENTIFIC	FALILITY ENERGY RAD TEST REQ CIRCUIT NO.	CO60 1.25MEV 386#1
SERIAL NUMBER ALL		DATE CODE 8327	LOG NUMBER 1123-1
DOSE GRAY(\$1) RATE (GRAY/SEC)	INITIAL 1.00E0 3.33=0		0.00E01 1.00E02 1.00=01 1.00=01
(1)1001 (VDD#15Y)	IN UAR		
2058V 2059V 2060V 2061V 2062V	0.0026 130 0.0029 115 0.0029 140 0.0047 130 0.0027 165	. 1500. . 1600.	5400. 9000. 5300. 9000. 5500. 9200. 5200. 8600. 5600. 9200.
MAX Mean Min Mean + 3 sig	.470=02 .165+0; .336=02 .136+0; .200=02 .115+0; MA .577=02 .192+0;	3 .159+04 . 3 .150+04 .	560+04
(8)1002 (VD0#15V)	IN UAL		
2058V 2059V 2060V 2061Y 206 <b>2</b> V	0.0019 120 0.0022 110 0.0066 130 0.0058 120 0.0029 155	1400. 1500.	5100. 8200. 5000. 8400. 5200. 8500. 4800. 7900. 5300. 8500.
MAX Mean Min Mean + 3 8igi	.660=02 .155+03 .388=02 .127+03 .190=02 .110+03 MA .104=01 .179+03	3 •148+04 • 5 •135+04 •	530+04
(3) VTN1 (ITN1##10)	UA) IN VOLTSI		
2058V 2059V 2060V 2061V 2062V	*1.55 1.63 *1.55 1.33 *1.59 1.24 *1.62 1.06 *1.54 1.33	5.15 5.68 5.62	12.26
Max Mean Min Mean + 3 bigh	154+01 .163+01 157+01 .132+01 164+01 .106+01 4A147+01 .194+01	•549+01 •515+01	123+02 .123+02 122+62 .100+02 120=02 .595+01 126+02 .194+02

		F	RADIATI	ON TEST	REBULTS	03/13/8	15
DEVICE MANUFA PACKAG TEST	ACTUI	RER		STATE SCI	ENTIFIC		060 25MEV 86=1
51	ERIAI	L NU	ALL ALL	LOT I	NUMBER	DATE CODE 8327	LOG NUMBER 1123-2
DOSE RATE		RAY( Ay/b		INITI	AL 2.00E0 1.00=0		0E03 0=01
(1) (1	/001	•15V	) IN U	A‡ (Cont	inued)		
		205 205 206 206 206	9 V 10 V 11 V	0.00; 0.00; 0.00; 0.00;	29 16000 29 16000 47 14800	. 27500. 41 . 28000. 41 . 29000. 40	000.
۱ ۱	1AX 1EAN 1IN 1EAN	+ 3	SIGMA	.470% .316% .260% .577%	0+851. SC	5 .281+05 .41 5 .270+05 .40	0+05 6+05 0+05 4+05
(2) (V	002=	157	) IN U	At (Conti	Inued)		
	IAX IEAN	205 205 206 206 206	9 V 0 V 1 V	0.00 0.00 0.00 0.00 0.00 0.00 0.00	14800 14700 18 13400 19 15200 12 152+0	. 24700. 32 . 25000. 32 . 27300. 32 . 26000. 32 5 .273+05 .32	000. 000. 000. 000. 000. 0+05
	EAN	+ 3	BIWMA	190=0	2 .134+0	5 .247+05 .32	0+05 0+05
(3) (1	TN1=	-10	UA) IN	VOLTSI	(Continued)		
		205 205 206 206 206	9 V 0 V 1 V	-1.5 -1.5 -1.5	5 12.1 19 12.1 2 8.3	6 11.89 1 3 11.73 1 3 12.10 1	2.08 2.10 2.02 1.89 2.13
M	AX EAN IN EAN	+ 3	SIGMA	*.154+0 *.157+0 *.162+0 *.147+0	1 .105+0	2 .120+02 .12	1+02 0+02 9+02 3+02

#### RADIATION TEST RESULTS

#### 03/13/85

DEVICE T MANUFACT PACKAGE TEST DAT	URER TYPE		TATE SCIENTIFIC	FACILITY ENERGY RAD TEST REG CIRCUIT NO.	CO60 1,25MEV 386+1
5ERI	AL N	JMBER ALL	LOT NUMBER	DATE CODE 6327	LOG NUMBER 1123-1
	GRAY(		INITIAL 1.00E0 3.33=0		.00E01 1.00E02
(4)YTN2	(ITN	2==10UA)	IN VOLTS:		
	205 205 205 205 205	59V 50V 51V	-1.76 1.39 -1.76 3.45 -1.79 1.56 -1.60 1.51 -1.73 1.66	7.84 7.82 7.36	12.54 5.95 12.54 12.26 12.54 6.34 12.58 12.35 12.58 7.56
MAX MEAI MIN MEAI	•		##173+01	795+01 736+01	126+02
(5)VTP1	(ITP1	#+1UUA)	IN VOLTS!		
	205 205 206 206	9 V 0 V 1 V	1.56 =0.60 1.50 =0.60 1.50 =0.60 1.51 =0.57 1.56 =0.60	-0.74 -0.74 -0.74	*0.93 *1.02 0.93 *0.99 *0.93 *1.02 *0.93 *0.99 *0.93 *1.02
MAX Mean Min Mean		SIGMA	•156+01570+00 •154+01594+00 •150+01600+00 •163+01554+00	740+005	930+00 = 990+00 556+00 = 101+01 930+00 = 102+01 94+01 = 959+00
(6) SALA(9)	1722	P+10UA)	IN VOLTS:		
	2050 2050 2060 2060 2060	) V ) V ) V	1.74 =0.63 1.74 =0.63 1.66 =0.63 1.69 =0.63 1.74 =0.66	-0.62 -0.82 -0.79	=0.96 =1.04 0.96 =1.05 =0.97 =1.05 =0.96 =1.04 =0.96 =1.04
MAX MEAN MIN MEAN		BIGMA	.174+02630+00 .171+01636+00 .166+01660+00 .183+01596+00	814+005 820+009	50+00 = 104+01 75+00 = 104+01 70+00 = 105+01 00+01 = 105+01

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